APPLICATIONS

- Aerospace analysis
- Amusement ride testing
- Automotive safety
- Biomechanics
- Blast testing
- Embedded monitoring
- Helicopter & aircraft
- Impact testing
- Injury investigation
- Parachute deployment
- Pedestrian head & leg form
- Ride & handling
- Sound measurement
- Sports & safety equipment
- Vibration testing

PRODUCTS

DTS offers a full line of data acquisition recorders and sensors for dynamic, high shock testing.

TDAS PRO SIM Sensor Input Standalone Data Recorder



TDAS PRO LAB SIM and TDAS PRO SIM (13.7 x 12.2 x 3.4 cm) are standalone data recorders with 8 fully-programmable sensor input channels that work with a variety of sensors.

Features

- Intuitive, easy-to-use software
- 8 fully-programmable sensor input channels with isolated excitation
- Ultra-low noise, sensor ID, high speed 16-bit ADC
- Lightweight, small size, cost-effective
- Durable, reliable, crashworthy unit tested to 100 g
- Comprehensive fault detection and self diagnosis
- LED indicators for power and event status
- · Ethernet, RS-232 and wireless communication options
- Built-in back-up battery with smart charge circuit in modules & racks
- Certified to NHTSA, FAA, ISO 6487 and SAE J211 data acquisition practices

The TDAS PRO Sensor Input Module (SIM) from DTS is a completely independent data acquisition system that can be used standalone or assembled into large test configurations by linking with DTS rack systems. The inherent 8-channel modularity increases productivity, offers greater flexibility and reduces downtime for calibration services. No other system offers these advantages.

Available in 2 models: TDAS PRO crashworthy, TDAS PRO LAB stationary



Fits in TDAS PRO 4- or 8-module rugged rack.

Fits in TDAS PRO LAB stationary rack.

Software

TDAS Control software provides easy-to-use tools for storing sensor information and performing data collection. Advanced features such as automatic sensor assignment, detailed channel diagnostics, and real-time data display supports successful testing and quality data every time.





Specifications

SERVICES

24/7 Worldwide Tech Support Calibration & Repair Services **Application Support** Software Integration **OEM/Embedded Applications**

OFFICES

Seal Beach, California USA Novi, Michigan USA Sydney, Australia Shanghai, China Zorge, Germany Tokyo, Japan

PHYSICAL		CALIBRATION	
Size:	13.7 x 12.2 x 3.4 cm (5.4 x 4.8 x 1.35")	Method:	Software controlled precision voltage insertion
	71 cm ³ per channel		with multiple shunt check options
Module Weight:	0.77 kg (1.7 lb), 96 g per channel	Voltage Insertion Type:	16-bit DAC
Compatibility:	Fits standard TDAS PRO Racks	Accuracy:	Better than 0.1% 100 ppm/°C, NIST traceable
			and software compensated
4 Module Rack Size:	14.7 x 19.6 x 12.7 cm (5.8 x 7.7 x 5.0")	Shunt Checks Using Re	esistors
4 Module Rack Weight:	~9 kg (~19 lb) – includes modules	Number:	7 Internal and 1 external
Madula Daala Ciaa	447	Values:	10k to 649k standard values, 0.1% 25 ppm
8 Module Rack Size: 8 Module Rock Weight:	14.7 X 33.8 X 12.7 CM (5.8 X 13.3 X 5.0)	Switching Resistance	C <2 onm, connected between +EX and +Signal substant Method
o wooule Rack weight.	~12 kg (~25 lb) – includes modules	Description:	Presiden auront applied to a Signal Allows
		Description.	virtually unlimited shupt check resolution
	0.50°C (22.122°E)		virtually uninflited shuff check resolution.
Shock:	100 G (32-122 F)		
Vibration:	6 a rms 55-1000 Hz 30 minutes	Resolution/Method:	Standard 16-bit successive approximation
יוטומנוטוו.	0 g mis, 55-1000 mz, 50 minutes		with simultaneous sampling of all channels
			(up to 25 ksps/channel)
	Differential software programmed	Max Sampling Rate:	304k samples/sec/module (38k on each of
Common Modo Pango:		Max. Oumphing Rate.	8 ch 100k on each of 3 ch etc.)
Protection.	+50 V	Relative Accuracy:	+4 LSB (0.006%)
Impedance:	50 megaohm typical	Storage Technique:	Circular memory buffer. Any portion of the
Gain Range	0.8 to 2000		memory may be allocated to pre-trigger data.
Overall Bandwidth	D C to 25 kHz	Memory Capacity:	1 M samples/channel
Noise Spectral Density:	$0.06 \text{ uV}/\sqrt{\text{Hz}}$ RTI typical. 0-4000 Hz	Memory Type:	Battery backed SRAM, retention >7 days
Signal to Noise Ratio:	80 dB typical at gains from 1-128		
Crosstalk:	<0.25% 10 V pp sq wave signal connected to	TRIGGERING SYSTI	EMS
	any channel with all other channels set to a	Each Module:	Conditioned contact closure input with T=0
	gain of 128 with 350 ohm bridges connected		received LED indicator
Accuracy:	0.2%, automatically calibrated each use by	Rack System:	Standard contact closure input, galvanically
	internal 16-bit DAC		and optically isolated to 1 kV.
Auto Offset Method:	Dual 12-bit DACs per channel		5-12 V optically coupled inputs available.
Auto Offset Range:	Gain 0.8-31: ±5.0 V, Gain ≥32: ±150 mV	Level Triggering:	Available from any channel in each module
Auto Offset Accuracy:	Typically <0.1% of A/D full scale		
Bridge Completion:	Software selected per channel, 1000 ohm std	SENSOR ID	
		Method:	Serial data read from a digital I/O line in each
ANTI-ALIAS FILTER	-IWO PER CHANNEL	T O	sensor connector
Fixed Low Pass:	8-pole Butterworth, 4.3 KHZ standard	Types Supported:	Maxim/Dallas
Adjustable Low Pass:	(2.9 KHZ driu 3.0 KHZ diso available)		
NUJUSIADIE LOW I 855.	from 50-3000 Hz	POWER External Valtage:	12 15 \/
SAF J211	System response meets SAF J211	Maximum Power:	IZ-15 V Depends largely upon connected sensors. I In
0/12 0211.	requirements	Waximum Tower.	to 900 mA per 8 channel module with
			350 ohm bridges and 10 V excitation on all
XCITATION			channels (\approx 8 0 A maximum for 64 channels)
Method:	Individually galvanically/optically isolated and	Protection:	Self-resetting fuses plus reverse current and
	software controlled		transient over-voltage protection.
Voltage Levels:	Off, 5.0, 10.0 V (2.0 & 10 V option)	Post-test Power	3.1
Accuracy:	Each ch software compensated (typ .1%)	Reduction:	Drops to ≈350 mA per 8 channel module
Rated Current:	50 mA per channel, continuous operation,	Back-up Power:	Rack & module contain rechargeable batteries
	individually current limited at ≈ 65 mA	Back-up Duration:	>10 minutes at full power
Short Circuit Recovery:	<1 msec typical		
		PC INTERFACE	
DIGITAL INPUTS		Module (standalone):	RS-232 @ 115.2 kHz (USB adapter available)
Method:	Sensor inputs may be used as event marker	Rack System (standard):	Ethernet 10BaseT and RS-232 @ 115.2 kHz
	channels with filters bypassed	Options:	Wireless Ethernet and USB adapter available
Propagation Delay:	0.02 msec		

Authorized DTS Representative:

software compensated ors ternal and 1 external to 649k standard values, 0.1% 25 ppm ohm, connected between +Ex and +Signal tion Method cision current applied to +Signal. Allows ually unlimited shunt check resolution. ONVERSION ndard 16-bit successive approximation simultaneous sampling of all channels to 25 ksps/channel) k samples/sec/module (38k on each of n., 100k on each of 3 ch., etc.) LSB (0.006%) cular memory buffer. Any portion of the mory may be allocated to pre-trigger data. samples/channel tery backed SRAM, retention >7 days ditioned contact closure input with T=0 eived LED indicator ndard contact closure input, galvanically optically isolated to 1 kV. 2 V optically coupled inputs available. ilable from any channel in each module ial data read from a digital I/O line in each sor connector xim/Dallas 15 V ends largely upon connected sensors. Up 00 mA per 8 channel module with ohm bridges and 10 V excitation on all nnels (≈8.0 A maximum for 64 channels) f-resetting fuses plus reverse current and sient over-voltage protection. ps to ≈350 mA per 8 channel module k & module contain rechargeable batteries minutes at full power -232 @ 115.2 kHz (USB adapter available) ernet 10BaseT and RS-232 @ 115.2 kHz eless Ethernet and USB adapter available CONTROL SOFTWARE Compatibility: Standard TDAS Control Software Operating Systems: Windows® XP, Vista, 7

